

(1.27 mm) .050"

FW-SM SERIES

MT MICRO BOARD STACKER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?FW-SM

Insulator Material:

Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze

Plating: Sn or Au over 50 µ" (1.27 µm) Ni Operating Temp Range: -55 °C to +125 °C RoHS Compliant: Yes

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (02-30) (0.15 mm) .006" max (31-50)* *(.004" stencil solution may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

Smaller stack heights

For added mechanical stability,

mechanical board spacers be

Contact ipg@samtec.com for

This Series is non-standard,

used in applications with gold or selective gold plated connectors.

Samtec recommends

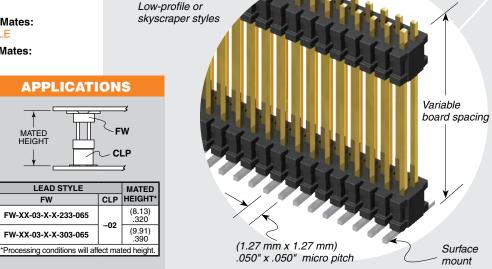
more information

non-returnable.

Board Mates:

.P, FLE

Cable Mates:





STACKER

HEIGHT

LEAD



LEAD

STYLE

Gold flash on post Matte Tin on tail

PLATING

OPTION

= 10 µ" (0.25 µm) **STACKER** Gold on post, + POST Matte Tin on tail

·"XXX" = Stacker Height (in inches)

STACKER

HEIGHT

Example: (6.35 mm) .250

-"XXX" = Post Height (in inches)

HEIGHT

(1.65 mm) .065" minimum

OPTION

= End Shroud (-075 post height only Mate only with CLP) (5.46 mm) .215" to (15.49 mm) .610" stacker height only 9 pins/row min.

-EP

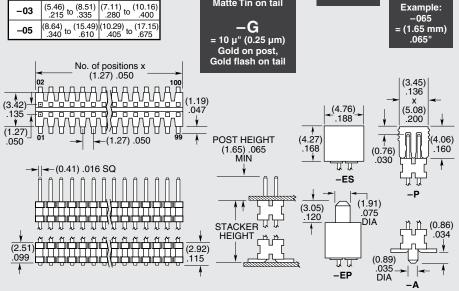
= End Shroud with Guide Post -075 post height only Mate only with CLP.) (5.46 mm) .215" to (15.49 mm) .610" stacker height only) 9 pins/row min.

–A

= Alignment Pin (3 positions min.) (5.46 mm) .215" to (15.75 mm) .620" stacker height only

= Pick & Place Pad (5 positions min.)

= Tape & Reel (Max overall height = Post+Stacker Height+ Pad+Alignment Pin = .700 (17.78))



Due to technical progress, all designs, specifications and components are subject to change without notice.

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